

L Number	Hits	Search Text	DB	Time stamp
21	0	reverse near2 gull near10 lead	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:34
28	5	reverse near3 gull	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:35
35	4	package and lead near4 (bent or inclined) same solder adj wetting	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:36
42	270	package and lead near4 (bent or inclined) near6 (acute or angle)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:39
-	3113	257/666.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:06
-	1329	257/692.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/18 16:01
-	831	257/696.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 09:56
-	185	257/694.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 09:51
-	151	257/695.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 09:52
-	55	257/696.cccls. and capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 09:57
-	272	257/672.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:08
-	1718	257/676.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:09
-	1268	257/690.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:09
-	276	438/111.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:15

-	154	438/117.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:17
-	784	438/123.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:22
-	1800	(small or low or decrease or decreased) near4 (area or foot or feet or footprint) near4 (lead or leadframe or package)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:25
-	46	(small or low or decrease or decreased) near4 (area or foot or feet or footprint) near4 (lead or leadframe or package) and (lead or foot) near3 (bottom or under or underneath) near3 (package or die or resin or body)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/19 10:33